## MOSFET - Power, N-Channel, SUPERFET III, FRFET 650 V, 40 A, 82 mΩ

# NTP082N65S3HF

#### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

#### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 70 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 81 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 722 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

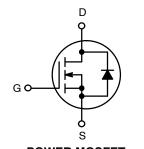
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar



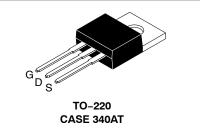
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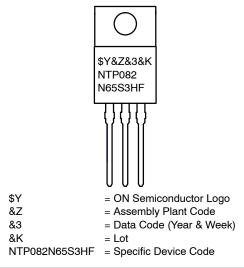
V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX I <sub>D</sub> MAX	
650 V	82 mΩ @ 10 V	40 A







#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V	
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V	
		– AC (f > 1 Hz)	±30		
I <sub>D</sub>	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	40	А	
		– Continuous (T <sub>C</sub> = 100°C)	25.5		
I <sub>DM</sub>	Drain Current	Single Pulsed Avalanche Energy (Note 2)		А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)			А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		3.13	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	313	W	
	– Derate Above 25°C		2.5	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8	9″ from Case for 5 seconds	300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 4.8 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 20 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTP082N65S3HF	NTP082N65S3HF	TO-220	Tube	N/A	N/A	50 Units

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS	•				
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}}  /  \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to $25^{\circ}C$		0.7		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μΑ
		$V_{DS}$ = 520 V, $T_{C}$ = 125°C		124		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}=\pm30~\text{V},~V_{DS}=0~\text{V}$			±100	nA
ON CHARACTE	RISTICS					-
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 4 \text{ mA}$	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		70	82	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		24		S
DYNAMIC CHA	RACTERISTICS	-				-
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz		3410		pF
C <sub>oss</sub>	Output Capacitance	1		70		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		722		pF

C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	3410	pF
C <sub>oss</sub>	Output Capacitance	7	70	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	722	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	126	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	81	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	24	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	7	32	nC
ESR	Equivalent Series Resistance	f = 1 MHz	1.9	Ω

SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	26	ns
t <sub>r</sub>	Turn-On Rise Time	$R_g = 3 \Omega$ (Note 4)	21	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		80	ns
t <sub>f</sub>	Turn-Off Fall Time		4.0	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			40	А
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current			100	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 20 A$		1.3	V
t <sub>rr</sub>	Reverse Recovery Time		108		ns
Q <sub>rr</sub>	Reverse Recovery Charge		410		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

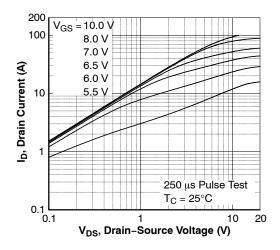
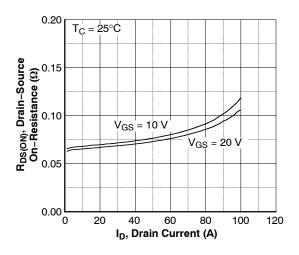
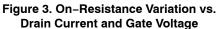


Figure 1. On-Region Characteristics





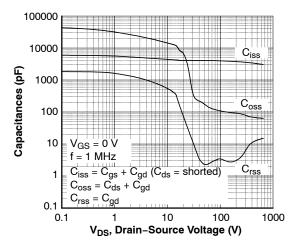


Figure 5. Capacitance Characteristics

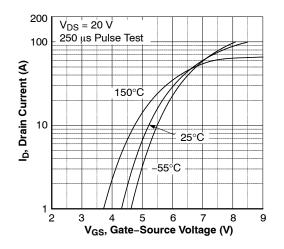
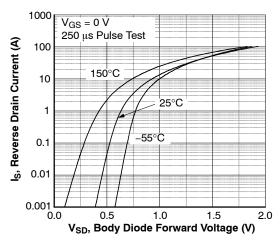


Figure 2. Transfer Characteristics





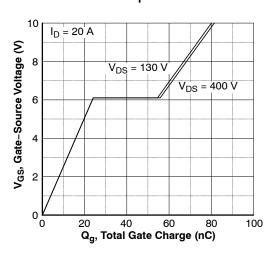
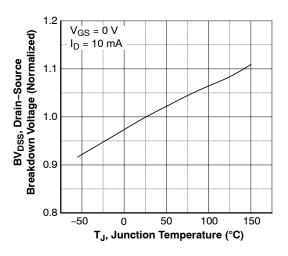
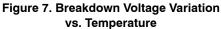


Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)





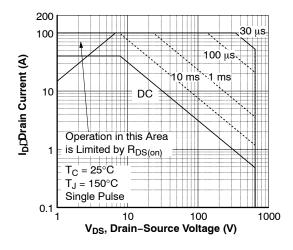


Figure 9. Maximum Safe Operating Area

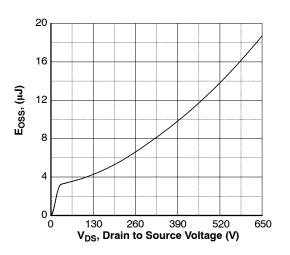


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

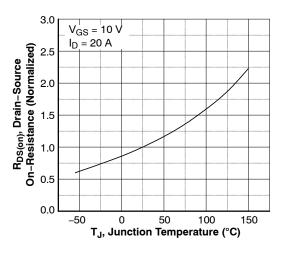


Figure 8. On–Resistance Variation vs. Temperature

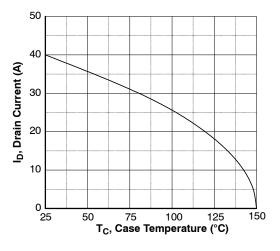


Figure 10. Maximum Drain Current vs. Case Temperature

## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

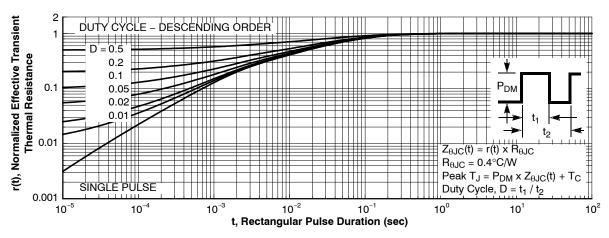
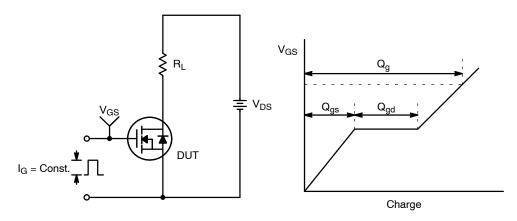


Figure 12. Transient Thermal Response Curve





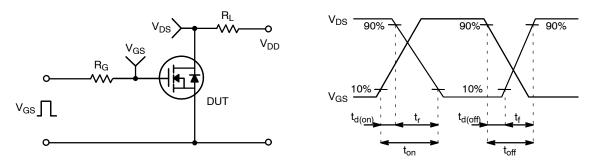
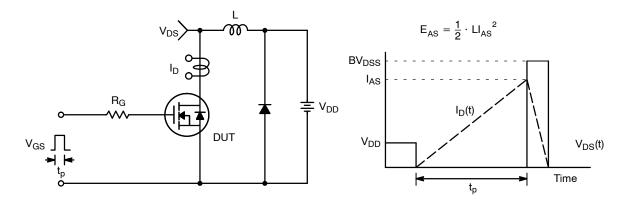


Figure 14. Resistive Switching Test Circuit & Waveforms





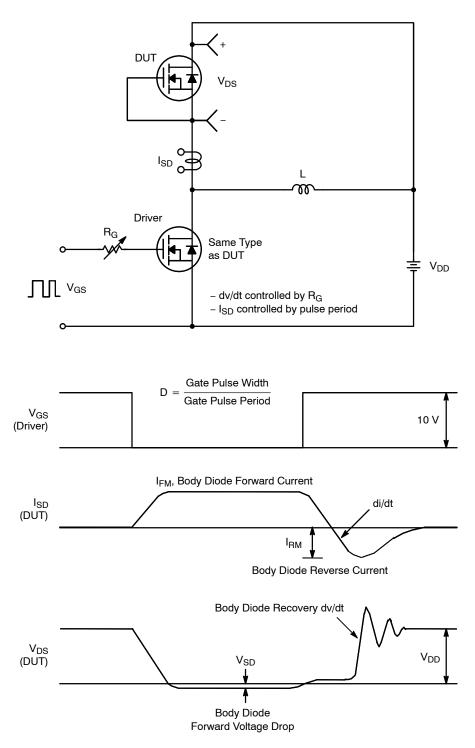
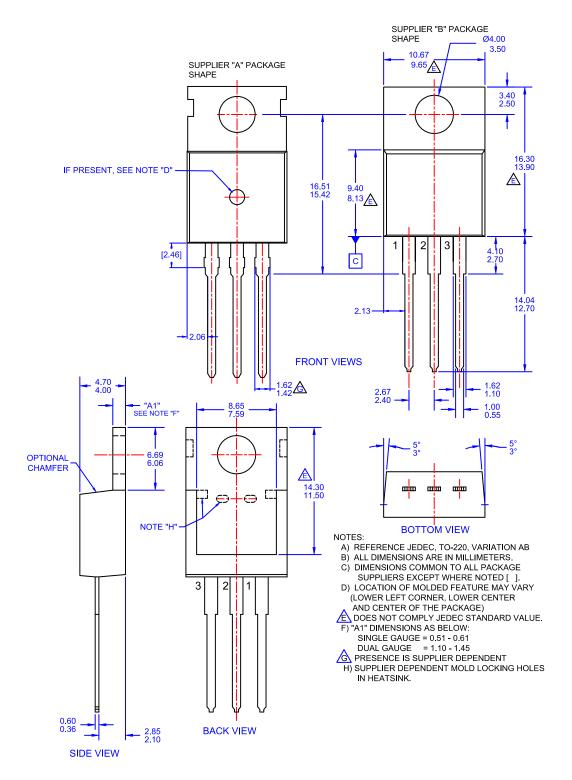


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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